





Description

Polytronics SMFF1206 series surface mount fast-acting fuse utilizes thick film process with extremely stable fusing element. The glass over coating can tolerate higher temperature profile, and the non-flammable ceramic substrate offers better heat conductivity and safety. SMFF1206 series is also RoHS compliant and halogen-free to meet global environmental standard.

Features

- Fast acting
- Compact size
- Thick film manufacturing method
- Ceramic substrate with silver fusing element
- Excellent environmental integrity



Application

- Battery pack
- Digital camera
- · Game equipment
- Wireless base station
- · LCD monitors and modules
- PC related equipment / peripherals
- Power supply
- Medical device

Agency Approval and Environmental Compliance

Agency File Number

UL/CSA:E331807

Regulation	Standard
RoHS	2011/65/EU
Halogen Free	IEC 61249-2-21:2003

Electrical Characteristics

Part Number	Marking	Current	Voltage	Interrupting Rating	Typical Cold	Typical I ² T [‡]	Agency Approval											
T di C Ndillibol	Marking	Rating (A)	Rating	g	DCR [†] (Ω)	(A ² S)	c '91 2°us											
SMFF1206P150	K	1.5			0.1150	0.0491	✓											
SMFF1206P200	N	2.0	32V DC	32V DC 50A / 32V DC	0.0640	0.1251	✓											
SMFF1206P250	0	2.5			0.0330	0.1255	✓											
SMFF1206P300	Р	3.0														0.0270	0.2880	✓
SMFF1206P350	R	3.5			0.0205	0.5366	✓											
SMFF1206P400	S	4.0			0.0155	0.8928	✓											
SMFF1206P500	Т	5.0	32V DC	254 / 201/ 00	0.0125	0.9325	✓											
SMFF1206P600	6	6.0		35A / 32V DC	0.0110	1.5192	✓											
SMFF1206P700	U	7.0			0.0072	2.2050	✓											

[†] Measured at≤10% rated current and 25°C

[‡] Melting I²T at 10 times of rated current



新竹市科學工業園區工業東四路 24-1 號 No. 24-1 Industry E. Rd. IV, Hsinchu Science Park, Hsinchu 300, Taiwan. TEL: +886-3-5643931 FAX: +886-3-5644624 http://www.pttc.com.tw



Electrical Specification

Ampere Rating	% of Current Rating	Opening Time
1.5070	100%	4 Hours Min.
1.5A~7A	250%	5 Seconds Max.

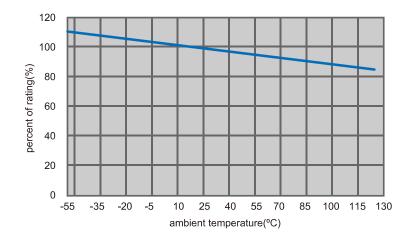
Physical Specifications

Materials	Substrate: Ceramic Terminations: Silver over-plated with 100% tin Element: Silver or Silver/palladium
Solderability	MIL-STD-202
Soldering Parameters	Wave Solder: 260°C, 10 seconds max. Reflow Solder: 260°C, 5 seconds max. Hand Solder: 350°C, 5 seconds max.

Environmental Specifications

Operating Temperature	-55°C to 125 °C

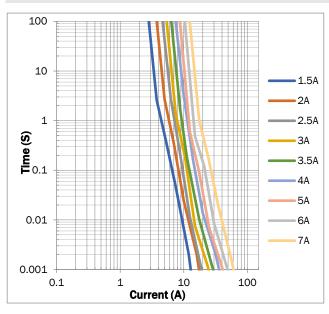
Thermal Derating Curve



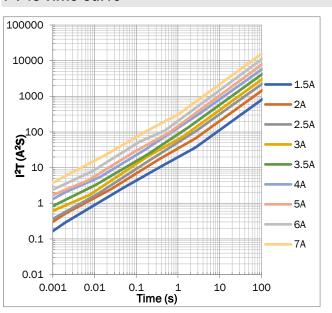




Time-Current Curve



I2T vs Time Curve



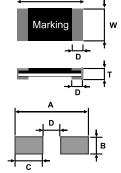
Physical Dimensions (mm.)

Dimensions (mm)

3.10±0.20 1.55±0.20 0.55±0.20 0.50±0.20	L	W	Т	D
	3.10±0.20	1.55±0.20	0.55±0.20	0.50±0.20

Recommended Solder Pad Dimension (mm)

А	В	С	D
4.4±0.5	2.4±0.3	1.2±0.3	2.0±0.3



Dimensions of Standard Test Board (mm)

Ampere Rating	Board Thickness	Copper Layer Thickness	Copper Trace Width
1.5A~6A	1.6	0.035	5.0
7A	1.6	0.070	7.5

Part Number







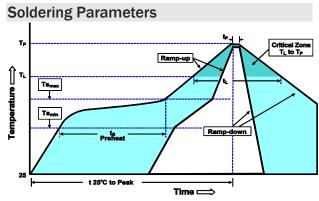


Reliability Test

Characteristics	Test condition / Methods	Requirement	Test Reference
Voltage Drop	100% In	Deviation between the mean value: <15%	IEC 60127-4
	100% In	No fusing, 4 hours min.	UL248-14
Time/Current	250% In	Within 5 seconds	Refer to Spec.
	1000%ln	>0.1ms	IEC60127-4
Endurance Test	100% In; 1hour on, 15min off, 100cycles; then following by 1hour at 125% In	ΔR : <10%	IEC 60127-4
Temperature Rise	100% In	ΙΔΤ I <75°C	IEC 60127-4
Interrupting Ability	50A / 32V DC (1.5mA~3.5A) 35A / 32V DC (4A~7A)	Without permanent arcing, ignition and bursting of fuse link	UL 248-14 IEC60127-4
Solderability	240°C ± 5°C, 3sec ± 0.5sec	95% coverage min	IEC 60127-4 MIL-STD-202 Method 208
Resistance to Soldering	260°C ± 5°C, 10sec ± 0.5sec	$ \Delta R $: <10% Legible appearance	MIL-STD-202 Method 210
Bending Test	Distance between holding points: 90mm Bending: 1 mm; Time, 10 seconds	$ \Delta R $: <10% No mechanical damages	IEC 60127-4
High Temperature Operating Life	70°C± 2°C at 60% In, 96 hours ;	ΔR : <10%; no fusing	MIL-STD-202 Method 108
Low Temperature Storage	-55°C± 3°C, 96 hours	ΔR : <10%	IEC 60068-2-1
High temperature Storage	125°C± 2°C, 96 hours	ΔR : <10%	IEC 60068-2-2
Humidity (Steady State)	40°C ± 2°C, 90~95%RH for 1000 hours	ΔR : <10%	MIL-STD-202 Method 103
Salt Spray	5% salt solution, 48 hours	$ \Delta R $: <10% Legible appearance	MIL-STD-202 Method 101
Thermal Shock	100 cycles between -65°C /+125°C 60 minutes at each extreme zone	ΔR : <10% No mechanical damage	MIL-STD-202 Method 107





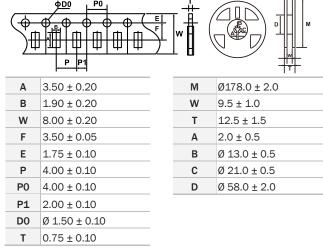


Average Ramp-Up Rate (Ts _{max} to T _P)	3°C/second max.
Preheat	
-Temperature Min (Ts _{min})	150°C
-Temperature Max (Ts _{max})	200°C
-Time (Ts _{min} to Ts _{max})	60-120 seconds
Time maintained above:	
-Temperature (T _L)	217°C
-Time (t _L)	20-30 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak	5 seconds
Temperature (t _P)	5 Seconds
Ramp-Down Rate	6°C /second max.
Time 25°C to Peak Temperature	8 minutes max.
NI I A AII I	City and the second

Note 1: All temperature refer to topside of the package, measured on the package body surface.

Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Tape & Reel Specification (mm.)



Packaging Quantity

Part Number	Tape & Reel Quantity
SMFF1206PXXX	5000

Storage

- The ambient temperature recommended for storage shall be between $5\,^{\circ}\text{C}$ ~30 $^{\circ}\text{C}.$
- The relative humidity recommended for storage shall be between 25%RH~60%RH.
- The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present.

Warning

- Fuse product is not recommended for any type of coating. Polytronics is not responsible for any damage directly or indirectly related to the coating.
- For copper layer thickness or copper trace width different from the standard test board, fusing characteristics
 needs to be verified to ensure product performance meet user requirement.



单击下面可查看定价,库存,交付和生命周期等信息

2>聚鼎